

Ordering Information (Note 4)

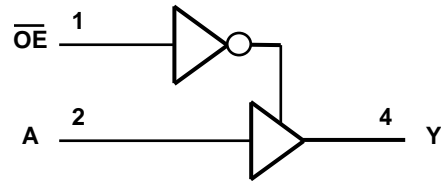
| Logic Device | Function | Package | Packing |
|---|--------------------------------------|--|---------------------|
| 74 : Logic Prefix LVC : 1.65 to 5.5 V Logic Family 1G : One Gate | 125: 3-State Buffer OE active low | W5 : SOT25 SE : SOT353 Z : SOT553 FS3 : X2-DFN0808-4 FW5 : X1-DFN1010-6 (Type B) FW4 : X2-DFN1010-6 FX4 : X2-DFN1409-6 FZ4 : X2-DFN1410-6 | -7 : 7" Tape & Reel |

| Part Number | Package Code | Package (Notes 5 & 6) | Package Size | 7" Tape and Reel | |
|-----------------|--------------|--|--|-------------------|--------------------|
| | | | | Quantity | Part Number Suffix |
| 74LVC1G125W5-7 | W5 | SOT25 | 3.0mm x 2.8mm x 1.2mm 0.95mm lead pitch | 3,000/Tape & Reel | -7 |
| 74LVC1G125SE-7 | SE | SOT353 | 2.0mm x 2.0mm x 1.1mm 0.65mm lead pitch | 3,000/Tape & Reel | -7 |
| 74LVC1G125Z-7 | Z | SOT553 | 1.6mm x 1.6 mm x 0.62mm 0.5mm lead pitch | 4,000/Tape & Reel | -7 |
| 74LVC1G125FS3-7 | FS3 | X2-DFN0808-4 | 0.8mm x 0.8 mm x 0.35mm 0.5mm pad pitch (diamond) | 5,000/Tape & Reel | -7 |
| 74LVC1G125FW5-7 | FW5 | X1-DFN1010-6 (Type B) | 1.0mm x 1.0mm x 0.5mm 0.35mm pad pitch | 5,000/Tape & Reel | -7 |
| 74LVC1G125FW4-7 | FW4 | X2-DFN1010-6 | 1.0mm x 1.0mm x 0.4mm 0.35mm pad pitch | 5,000/Tape & Reel | -7 |
| 74LVC1G125FX4-7 | FX4 | X2-DFN1409-6 (Chip scale alternative) | 1.4mm x 0.9mm x 0.4mm 0.5mm pad pitch | 5,000/Tape & Reel | -7 |
| 74LVC1G125FZ4-7 | FZ4 | X2-DFN1410-6 | 1.4mm x 1.0mm x 0.4mm 0.5mm pad pitch | 5,000/Tape & Reel | -7 |

- Notes:
- For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 - Pad layout as shown on Diodes Inc. suggested pad layout which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - The taping orientation is located on our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Pin Descriptions

| Pin Name | Description |
|------------------------|----------------|
| $\overline{\text{OE}}$ | Output Enable |
| A | Data Input |
| GND | Ground |
| Y | Data Output |
| V _{CC} | Supply Voltage |
| NC | No Connection |

Logic Diagram

Function Table

| Inputs | | Output |
|------------------------|---|--------|
| $\overline{\text{OE}}$ | A | Y |
| L | H | H |
| L | L | L |
| H | X | Z |

Absolute Maximum Ratings (Notes 7 & 8) (@T_A = +25°C, unless otherwise specified.)

| Symbol | Description | Rating | Unit |
|-----------------------------------|---|------------------------------|------|
| ESD HBM | Human Body Model ESD Protection | 2 | kV |
| ESD CDM | Charged Device Model ESD Protection | 1 | kV |
| ESD MM | Machine Model ESD Protection | 200 | V |
| V _{CC} | Supply Voltage Range | -0.5 to 6.5 | V |
| V _I | Input Voltage Range | -0.5 to 6.5 | V |
| V _O | Voltage Applied to Output in High Impedance or I _{OFF} State | -0.5 to 6.5 | V |
| V _O | Voltage Applied to Output in High or Low State. | -0.5 to V _{CC} +0.5 | V |
| I _{IK} | Input Clamp Current V _I < 0 | -50 | mA |
| I _{OK} | Output Clamp Current | -50 | mA |
| I _O | Continuous Output Current | ±50 | mA |
| I _{CC} , I _{GN} | Continuous Current Through V _{CC} or GND | ±100 | mA |
| T _J | Operating Junction Temperature | -40 to +150 | °C |
| T _{STG} | Storage Temperature | -65 to +150 | °C |

- Notes:
- Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
 - Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

Recommended Operating Conditions (Note 9) (@T_A = +25°C, unless otherwise specified.)

| Symbol | Parameter | Min | Max | Unit |
|-----------------|------------------------------------|---|------------------------|------|
| V _{CC} | Operating Voltage | 1.65 | 5.5 | V |
| | Data Retention Only | 1.5 | — | V |
| V _{IH} | High-Level Input Voltage | V _{CC} = 1.65V to 1.95V | 0.65 x V _{CC} | V |
| | | V _{CC} = 2.3V to 2.7V | 1.7 | |
| | | V _{CC} = 3V to 3.6V | 2 | |
| | | V _{CC} = 4.5V to 5.5V | 0.7 x V _{CC} | |
| V _{IL} | Low-Level Input voltage | V _{CC} = 1.65V to 1.95V | — | V |
| | | V _{CC} = 2.3V to 2.7V | — | |
| | | V _{CC} = 3V to 3.6V | — | |
| | | V _{CC} = 4.5V to 5.5V | — | |
| V _I | Input Voltage | 0 | 5.5 | V |
| V _O | Output Voltage | 0 | V _{CC} | V |
| I _{OH} | High-Level Output Current | V _{CC} = 1.65V | — | mA |
| | | V _{CC} = 2.3V | — | |
| | | V _{CC} = 2.7V | — | |
| | | V _{CC} = 3V | — | |
| | | V _{CC} = 4.5V | — | |
| | | V _{CC} = 5.5V | — | |
| I _{OL} | Low-Level Output Current | V _{CC} = 1.65V | — | mA |
| | | V _{CC} = 2.3V | — | |
| | | V _{CC} = 2.7V | — | |
| | | V _{CC} = 3V | — | |
| | | V _{CC} = 4.5V | — | |
| | | V _{CC} = 5.5V | — | |
| Δt/ΔV | Input Transition Rise or Fall Rate | V _{CC} = 1.8V ± 0.15V, 2.5V ± 0.2V | — | ns/V |
| | | V _{CC} = 3.3V ± 0.3V | — | |
| | | V _{CC} = 5V ± 0.5V | — | |
| T _A | Operating Free-Air Temperature | — | -40 | °C |

Note: 9. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = +25^\circ C$)

| Symbol | Parameter | Test Conditions | V_{CC} | -40°C to +85°C | | | -40°C to +125°C | | Unit |
|-----------------|----------------------------|----------------------------------|---------------|----------------|-----------|----------|-----------------|-----------|---------|
| | | | | Min | Typ | Max | Min | Max | |
| V_{OH} | High-Level Output Voltage | $I_{OH} = -100\mu A$ | 1.65V to 5.5V | $V_{CC} - 0.1$ | — | — | $V_{CC} - 0.1$ | — | V |
| | | $I_{OH} = -4mA$ | 1.65V | 1.2 | — | — | 0.95 | — | |
| | | $I_{OH} = -8mA$ | 2.3V | 1.9 | — | — | 1.7 | — | |
| | | $I_{OH} = -12mA$ | 2.7V | 2.2 | — | — | 1.9 | — | |
| | | $I_{OH} = -16mA$ | 3V | 2.4 | — | — | 2.2 | — | |
| | | $I_{OH} = -24mA$ | | 2.3 | — | — | 2.0 | — | |
| | | $I_{OH} = -32mA$ | 4.5V | 3.8 | — | — | 3.4 | — | |
| V_{OL} | Low-Level Output Voltage | $I_{OL} = 100\mu A$ | 1.65V to 5.5V | — | — | 0.1 | — | 0.1 | V |
| | | $I_{OL} = 4mA$ | 1.65V | — | — | 0.45 | — | 0.7 | |
| | | $I_{OL} = 8mA$ | 2.3V | — | — | 0.3 | — | 0.45 | |
| | | $I_{OL} = 12mA$ | 2.7V | — | — | 0.4 | — | 0.6 | |
| | | $I_{OL} = 16mA$ | 3V | — | — | 0.4 | — | 0.6 | |
| | | $I_{OL} = 24mA$ | | — | — | 0.55 | — | 0.8 | |
| | | $I_{OL} = 32mA$ | 4.5V | — | — | 0.55 | — | .8 | |
| I_I | Input Current | $V_I = 5.5V$ or GND | 0 to 5.5V | — | ± 0.1 | ± 5 | — | ± 100 | μA |
| I_{OFF} | Power Down Leakage Current | V_I or $V_O = 5.5V$ | 0V | — | — | ± 10 | — | ± 200 | μA |
| I_{OZ} | Z State Leakage Current | $V_O = 0$ to 5.5V | 3.6V | | 0.1 | 10 | | 20 | μA |
| I_{CC} | Supply Current | $V_I = 5.5V$ or GND $I_O = 0$ | 5.5V | — | 0.1 | 10 | — | 200 | μA |
| ΔI_{CC} | Additional Supply Current | Input at $V_{CC} - 0.6V$ | 3V to 5.5V | — | — | 500 | — | 5,000 | μA |
| C_i | Input Capacitance | $V_I = V_{CC} -$ or GND | 3.3V | — | 5 | — | — | — | pF |

Package Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = +25^\circ C$)

| Symbol | Parameter | Test Conditions | V_{CC} | Min | Typ | Max | Unit |
|---------------|--|-----------------------|-----------|-----|-----|-----|--------------|
| θ_{JA} | Thermal Resistance Junction-to-Ambient | SOT25 | (Note 10) | — | 204 | — | $^\circ C/W$ |
| | | SOT353 | | — | 371 | — | |
| | | SOT553 | | — | 231 | — | |
| | | X2-DFN0808-4 | | — | 400 | — | |
| | | X1-DFN1010-6 (Type B) | | — | 435 | — | |
| | | X2-DFN1010-6 | | — | 445 | — | |
| | | X2-DFN1409-6 | | — | 470 | — | |
| | | X2-DFN1410-6 | | — | 460 | — | |
| θ_{JC} | Thermal Resistance Junction-to-Case | SOT25 | (Note 10) | — | 52 | — | $^\circ C/W$ |
| | | SOT353 | | — | 143 | — | |
| | | SOT553 | | — | 105 | — | |
| | | X2-DFN0808-4 | | — | 225 | — | |
| | | X1-DFN1010-6 (Type B) | | — | 250 | — | |
| | | X2-DFN1010-6 | | — | 250 | — | |
| | | X2-DFN1409-6 | | — | 275 | — | |
| | | X2-DFN1410-6 | | — | 265 | — | |

Note: 10. Test condition for each of the eight package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

Figure 1 Typical Values at $T_A = +25^\circ\text{C}$ and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

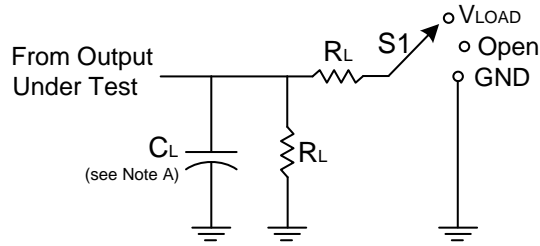
| Parameter | From Input | To Output | V_{CC} | $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ | | | $T_A = -40^\circ\text{C to } +125^\circ\text{C}$ | | Unit |
|-----------|-----------------|-----------|-------------------|---|-----|-----|--|------|------|
| | | | | Min | Typ | Max | Min | Max | |
| t_{pd} | A | Y | 1.8V \pm 0.15V | 1.0 | 3.3 | 8.0 | 1.0 | 10.5 | ns |
| | | | 2.5V \pm 0.2V | 0.5 | 2.2 | 5.5 | 0.5 | 7.0 | |
| | | | 2.7V | 0.5 | 2.5 | 5.5 | 0.5 | 7.5 | |
| | | | 3.3V \pm 0.3V | 0.5 | 2.1 | 4.5 | 0.5 | 6.0 | |
| | | | 5.0V \pm 0.5V | 0.5 | 1.7 | 4.0 | 0.5 | 5.5 | |
| t_{en} | \overline{OE} | Y | 1.8 V \pm 0.15V | 1.0 | 4.1 | 9.4 | 1.0 | 12.0 | ns |
| | | | 2.5V \pm 0.2V | 0.5 | 2.8 | 6.6 | 0.5 | 8.5 | |
| | | | 2.7V | 0.5 | 3.3 | 6.6 | 0.5 | 8.5 | |
| | | | 3.3V \pm 0.3V | 0.5 | 2.4 | 5.3 | 0.5 | 7.0 | |
| | | | 5.0V \pm 0.5V | 0.5 | 2.1 | 5.0 | 0.5 | 6.5 | |
| t_{dis} | \overline{OE} | Y | 1.8V \pm 0.15V | 1.0 | 4.3 | 9.2 | 1.0 | 12.0 | ns |
| | | | 2.5V \pm 0.2V | 0.5 | 2.7 | 5.0 | 0.5 | 6.5 | |
| | | | 2.7V | 0.5 | 3.0 | 5.0 | 0.5 | 6.5 | |
| | | | 3.3V \pm 0.3V | 0.5 | 3.1 | 5.0 | 0.5 | 6.5 | |
| | | | 5.0V \pm 0.5V | 0.5 | 2.2 | 4.2 | 0.5 | 5.5 | |

Operating Characteristics

$T_A = +25^\circ\text{C}$

| Parameter | | | Test Conditions | $V_{CC} = 1.8\text{V}$ | $V_{CC} = 2.5\text{V}$ | $V_{CC} = 3.3\text{V}$ | $V_{CC} = 5\text{V}$ | Unit |
|-----------|-------------------------------|------------------|--------------------|------------------------|------------------------|------------------------|----------------------|------|
| | | | | Typ | Typ | Typ | Typ | |
| C_{pd} | Power Dissipation Capacitance | Outputs Enabled | $f = 10\text{MHz}$ | 19 | 19 | 19 | 21 | pF |
| | | Outputs Disabled | | 2 | 2 | 3 | 4 | |

Parameter Measurement Information



| TEST | S1 |
|-------------------|------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | V_{LOAD} |
| t_{PHZ}/t_{PZH} | GND |

| V_{CC} | Inputs | | V_M | V_{LOAD} | C_L | R_L | V_{Δ} |
|------------------|----------|--------------|------------|-------------------|-------|--------------|--------------|
| | V_I | t_r/t_f | | | | | |
| $1.8V \pm 0.15V$ | V_{CC} | $\leq 2ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF | 1k Ω | 0.15V |
| $2.5V \pm 0.2V$ | V_{CC} | $\leq 2ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF | 500 Ω | 0.15V |
| 2.7V | 2.7V | $\leq 2.5ns$ | 1.5V | 6V | 50pF | 500 Ω | 0.3V |
| $3.3V \pm 0.3V$ | 3V | $\leq 2.5ns$ | 1.5V | 6V | 50pF | 500 Ω | 0.3V |
| $5V \pm 0.5V$ | V_{CC} | $\leq 2.5ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50pF | 500 Ω | 0.3V |

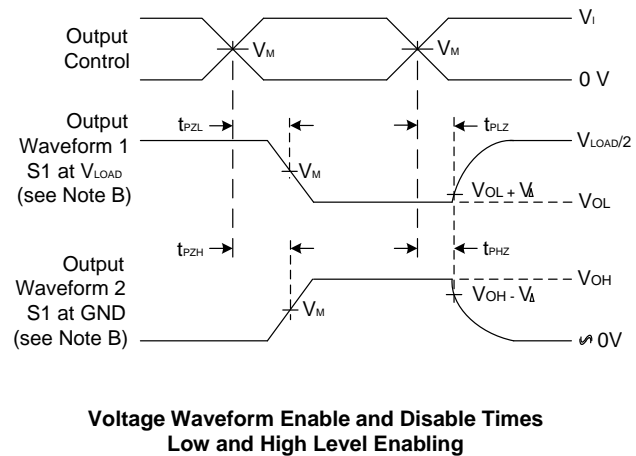
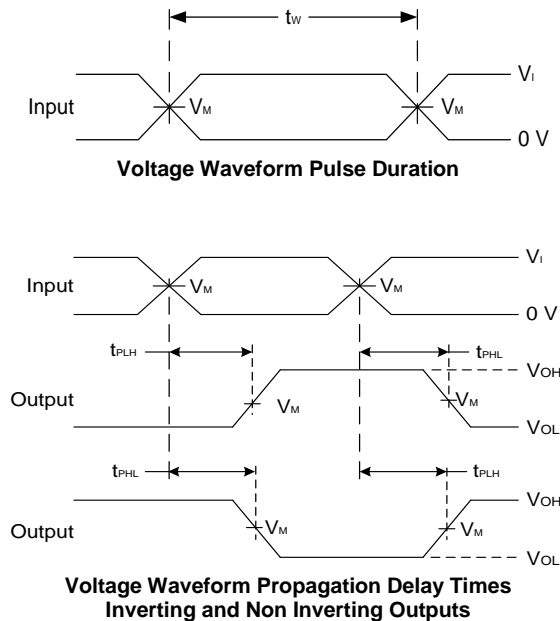
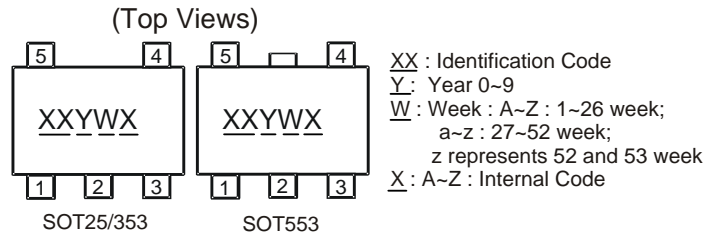


Figure 1 Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate $\leq 10MHz$.
 - C. Inputs are measured separately one transition per measurement.
 - D. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - E. t_{PZL} and t_{PZH} are the same as t_{EN} .
 - F. t_{PLH} and t_{PHL} are the same as t_{PD} .

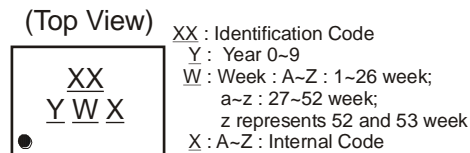
Marking Information

(1) SOT25, SOT353 and SOT553



| Part Number | Package | Identification Code |
|----------------|---------|---------------------|
| 74LVC1G125W5-7 | SOT25 | UY |
| 74LVC1G125SE-7 | SOT353 | UY |
| 74LVC1G125Z-7 | SOT553 | UY |

(2) DFN Packages

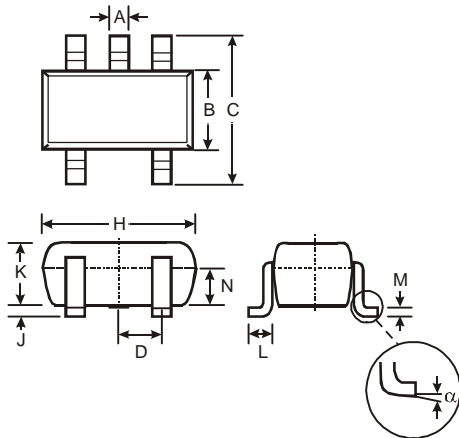


| Part Number | Package | Identification Code |
|-----------------|-----------------------|---------------------|
| 74LVC1G125FS3-7 | X2-DFN0808-4 | WY |
| 74LVC1G125FW5-7 | X1-DFN1010-6 (Type B) | VY |
| 74LVC1G125FW4-7 | X2-DFN1010-6 | UY |
| 74LVC1G125FX4-7 | X2-DFN1409-6 | MW |
| 74LVC1G125FZ4-7 | X2-DFN1410-6 | UY |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT25

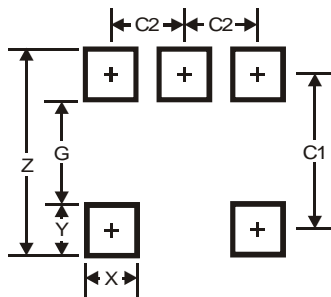


| SOT25 | | | |
|----------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A | 0.35 | 0.50 | 0.38 |
| B | 1.50 | 1.70 | 1.60 |
| C | 2.70 | 3.00 | 2.80 |
| D | - | - | 0.95 |
| H | 2.90 | 3.10 | 3.00 |
| J | 0.013 | 0.10 | 0.05 |
| K | 1.00 | 1.30 | 1.10 |
| L | 0.35 | 0.55 | 0.40 |
| M | 0.10 | 0.20 | 0.15 |
| N | 0.70 | 0.80 | 0.75 |
| α | 0° | 8° | - |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT25

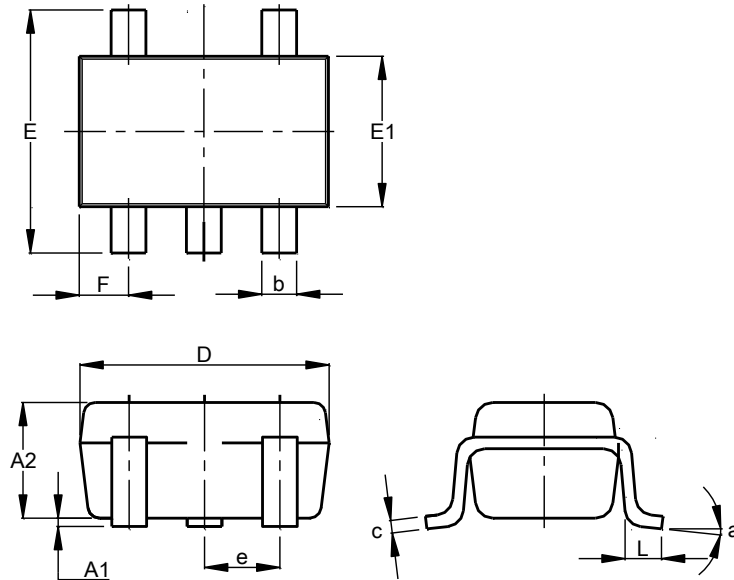


| Dimensions | Value |
|------------|-------|
| Z | 3.20 |
| G | 1.60 |
| X | 0.55 |
| Y | 0.80 |
| C1 | 2.40 |
| C2 | 0.95 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT353

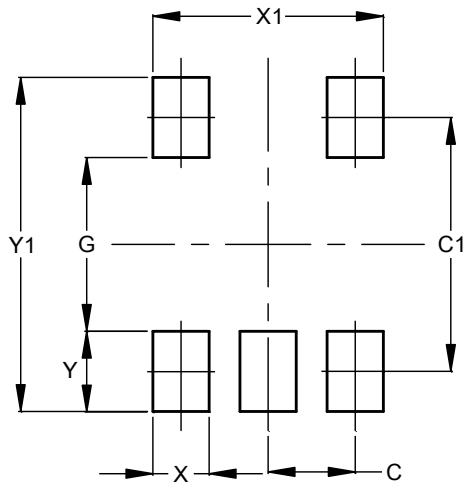


| SOT353 | | | |
|----------------------|-----------|------|-------|
| Dim | Min | Max | Typ |
| A1 | 0.00 | 0.10 | 0.05 |
| A2 | 0.90 | 1.00 | 1.00 |
| b | 0.10 | 0.30 | 0.25 |
| c | 0.10 | 0.22 | 0.11 |
| D | 1.80 | 2.20 | 2.15 |
| E | 2.00 | 2.20 | 2.10 |
| E1 | 1.15 | 1.35 | 1.30 |
| e | 0.650 BSC | | |
| F | 0.40 | 0.45 | 0.425 |
| L | 0.25 | 0.40 | 0.30 |
| a | 0° | 8° | -- |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT353

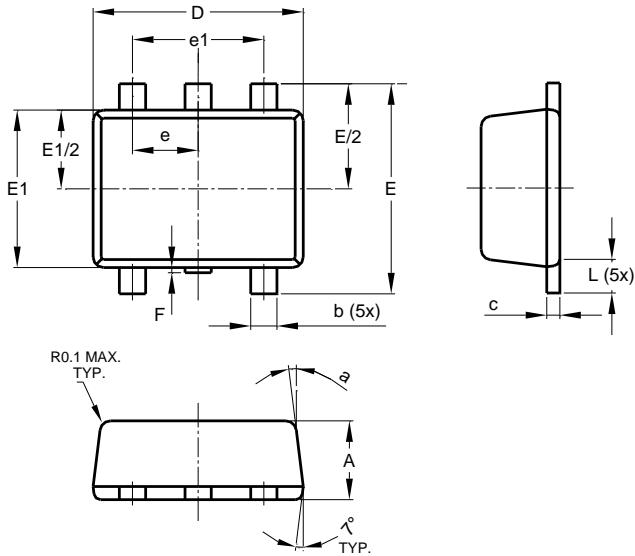


| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.650 |
| C1 | 1.900 |
| G | 1.300 |
| X | 0.420 |
| X1 | 1.720 |
| Y | 0.600 |
| Y1 | 2.500 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT553

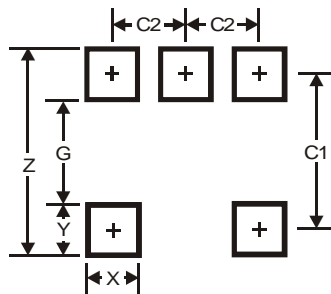


| SOT553 | | | |
|----------------------|----------|------|------|
| Dim | Min | Max | Typ |
| A | 0.55 | 0.62 | 0.60 |
| b | 0.15 | 0.30 | 0.20 |
| c | 0.10 | 0.18 | 0.15 |
| D | 1.50 | 1.70 | 1.60 |
| E | 1.55 | 1.70 | 1.60 |
| E1 | 1.10 | 1.25 | 1.20 |
| e | 0.50 BSC | | |
| e1 | 1.00 BSC | | |
| F | 0.00 | 0.10 | — |
| L | 0.10 | 0.30 | 0.20 |
| a | 6° | 8° | 7° |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT553

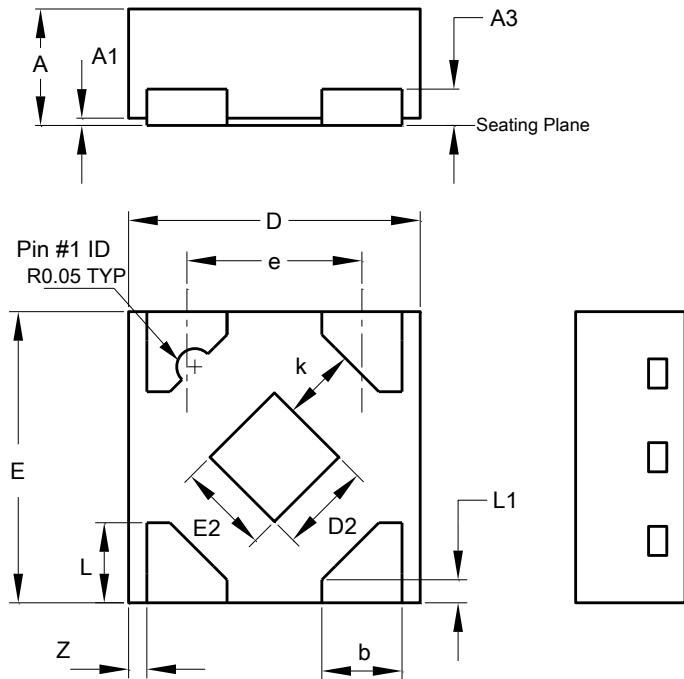


| Dimensions | Value |
|------------|-------|
| Z | 2.2 |
| G | 1.2 |
| X | 0.375 |
| Y | 0.5 |
| C1 | 1.7 |
| C2 | 0.5 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN0808-4

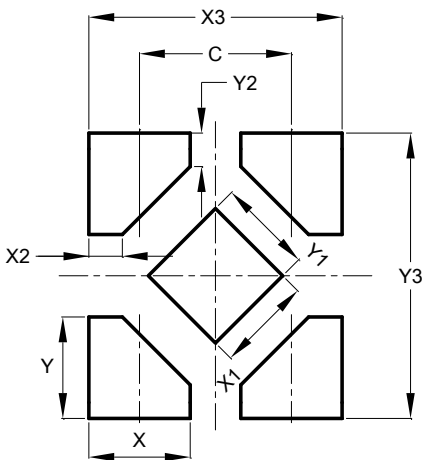


| X2-DFN0808-4 | | | |
|----------------------|------|------|------|
| Dim | Min | Max | Typ |
| A | 0.25 | 0.35 | 0.30 |
| A1 | 0 | 0.04 | 0.02 |
| A3 | - | - | 0.13 |
| b | 0.17 | 0.27 | 0.22 |
| D | 0.75 | 0.85 | 0.80 |
| D2 | 0.15 | 0.35 | 0.25 |
| E | 0.75 | 0.85 | 0.80 |
| E2 | 0.15 | 0.35 | 0.25 |
| e | - | - | 0.48 |
| k | 0.20 | - | - |
| L | 0.17 | 0.27 | 0.22 |
| L1 | 0.02 | 0.12 | 0.07 |
| z | - | - | 0.05 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN0808-4

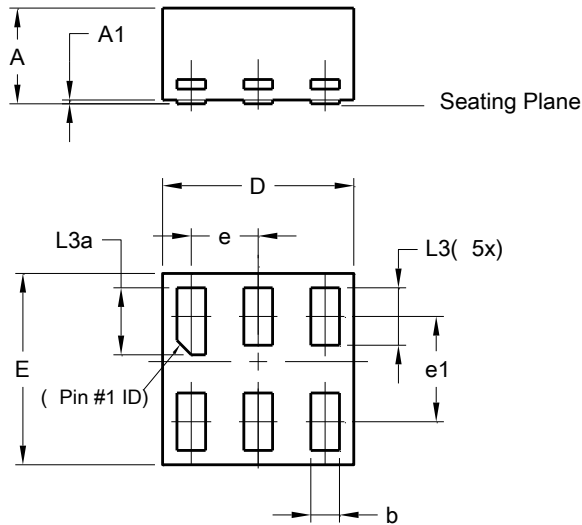


| Dimensions | Value |
|------------|-------|
| C | 0.480 |
| X | 0.320 |
| X1 | 0.300 |
| X2 | 0.106 |
| X3 | 0.800 |
| Y | 0.320 |
| Y1 | 0.300 |
| Y2 | 0.106 |
| Y3 | 0.900 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-DFN1010-6 (Type B)

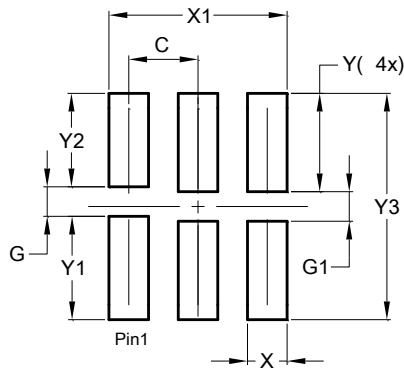


| X1-DFN1010-6 (Type B) | | | |
|--------------------------|----------|-------|------|
| Dim | Min | Max | Typ |
| A | - | 0.50 | 0.39 |
| A1 | - | 0.04 | - |
| b | 0.12 | 0.20 | 0.15 |
| D | 0.95 | 1.050 | 1.00 |
| E | 0.95 | 1.050 | 1.00 |
| e | 0.35 BSC | | |
| e1 | 0.55 BSC | | |
| L3 | 0.27 | 0.30 | 0.30 |
| L3a | 0.32 | 0.40 | 0.35 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-DFN1010-6 (Type B)

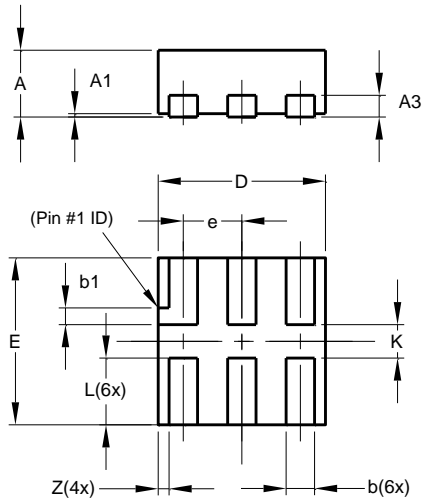


| Dimensions | Value (in mm) |
|------------|------------------|
| C | 0.350 |
| G | 0.150 |
| G1 | 0.150 |
| X | 0.200 |
| X1 | 0.900 |
| Y | 0.500 |
| Y1 | 0.525 |
| Y2 | 0.475 |
| Y3 | 1.150 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1010-6

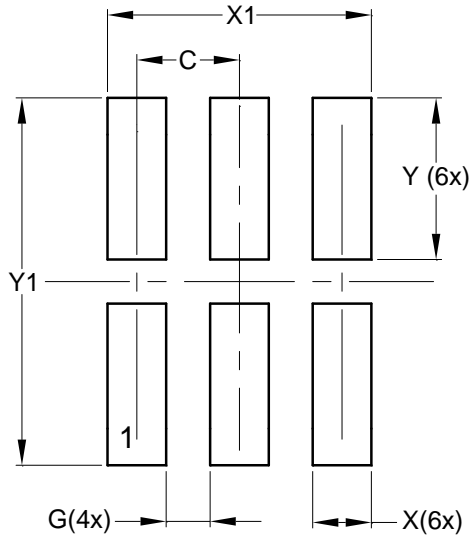


| X2-DFN1010-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.14 | 0.20 | 0.17 |
| b1 | 0.05 | 0.15 | 0.10 |
| D | 0.95 | 1.05 | 1.00 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.35 |
| L | 0.35 | 0.45 | 0.40 |
| K | 0.15 | — | — |
| Z | — | — | 0.065 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1010-6

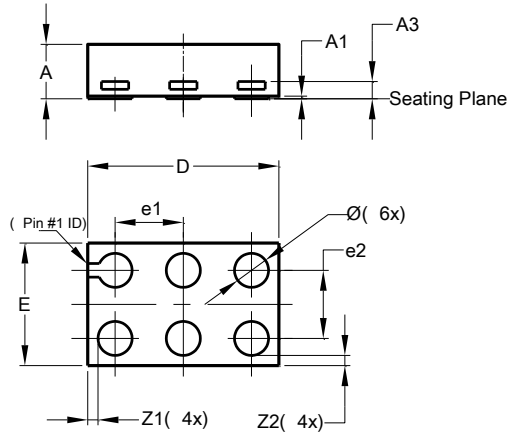


| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.350 |
| G | 0.150 |
| X | 0.200 |
| X1 | 0.900 |
| Y | 0.550 |
| Y1 | 1.250 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1409-6 CHIP SCALE ALTERNATIVE

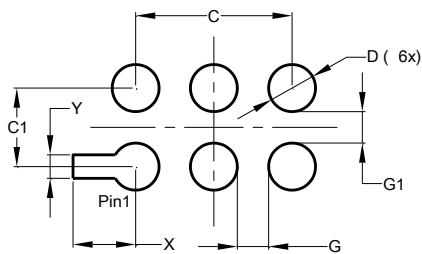


| X2-DFN1409-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | - | 0.40 | 0.39 |
| A1 | 0 | 0.05 | 0.02 |
| A3 | - | - | 0.13 |
| Ø | 0.20 | 0.30 | 0.25 |
| D | 1.35 | 1.45 | 1.40 |
| E | 0.85 | 0.95 | 0.90 |
| e1 | - | - | 0.50 |
| e2 | - | - | 0.50 |
| Z1 | - | - | 0.075 |
| Z2 | - | - | 0.075 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1409-6 CHIP SCALE ALTERNATIVE

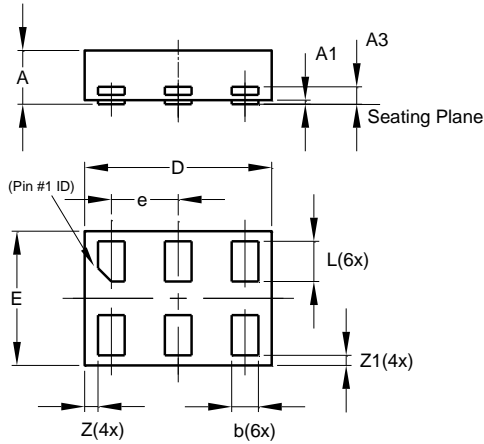


| Dimensions | Value (in mm) |
|------------|---------------|
| C | 1.000 |
| C1 | 0.500 |
| D | 0.300 |
| G | 0.200 |
| G1 | 0.200 |
| X | 0.400 |
| Y | 0.150 |

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1410-6

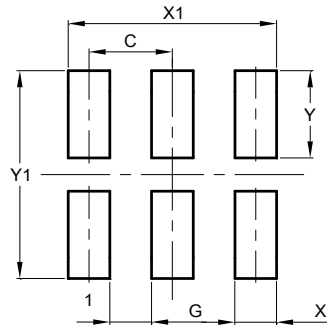


| X2-DFN1410-6 | | | |
|----------------------|-------|-------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.15 | 0.25 | 0.20 |
| D | 1.35 | 1.45 | 1.40 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.50 |
| L | 0.25 | 0.35 | 0.30 |
| Z | — | — | 0.10 |
| Z1 | 0.045 | 0.105 | 0.075 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN1410-6



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.500 |
| G | 0.250 |
| X | 0.250 |
| X1 | 1.250 |
| Y | 0.525 |
| Y1 | 1.250 |

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